

Product Summary

V _{RRM} (V)	I _O (A)	V _F Max (V) @ +25°C	I _R Max (mA) @ +25°C
40	1	0.51	0.1

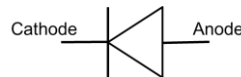
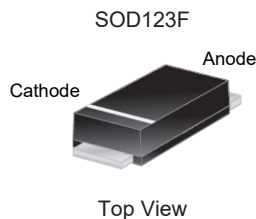
Features and Benefits

- Low-Forward Voltage (V_F) Minimizes Conduction Losses and Improves Efficiency
- Patented Super Barrier Rectifier Technology (SBR®)
- Reduced High-Temperature Reverse Leakage; Increased Reliability Against Thermal Runaway Failure in High-Temperature Operation
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.**
<https://www.diodes.com/quality/product-definitions/>
- An automotive-compliant part is available under a separate datasheet (SBR140S1FQ)**

Description and Applications

The SBR140S1F is a single rectifier packaged in SOD123F. Offering low V_F and excellent high-temperature stability, this device is ideal for use in general rectification applications as:

- Boost diodes
- Blocking diodes



Mechanical Data

- Package: SOD123F
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Band
- Weight: 0.015 grams (Approximate)

Ordering Information (Note 4)

Orderable Part Number	Package	Packing	
		Qty.	Carrier
SBR140S1F-7	SOD123F	3,000	Tape & Reel

- Notes:
- EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 - See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>

Marking Information



F4 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: N = 2026)
M = Month (ex: 9 = September)

Date Code Key

Year	2012	-	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035
Code	Z	-	N	P	R	S	T	U	V	W	X	Y

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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SBR140S1F

Document number: DS36043 Rev. 6 - 2

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	V
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current	I _O	1	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	30	A

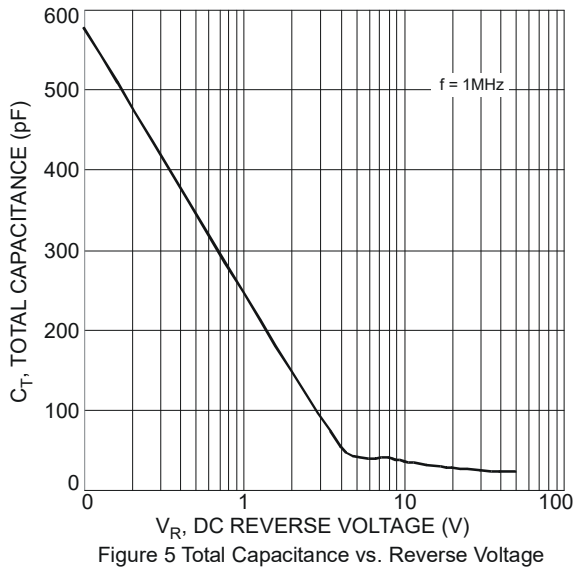
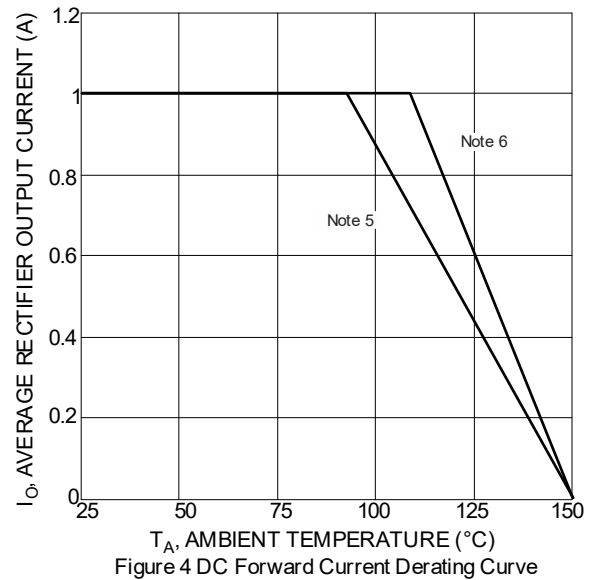
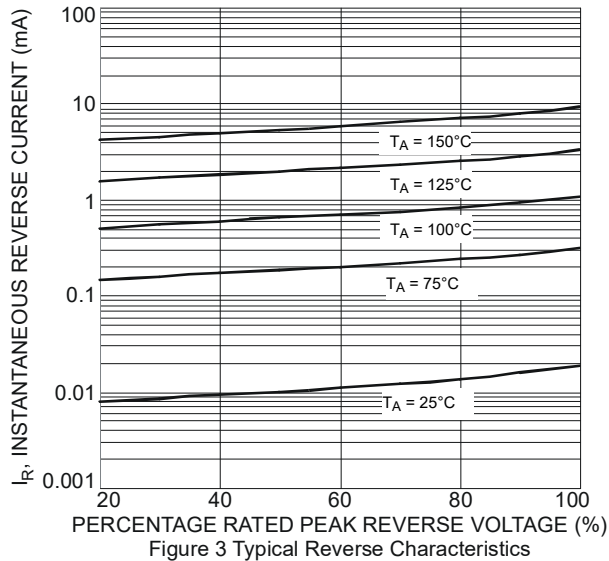
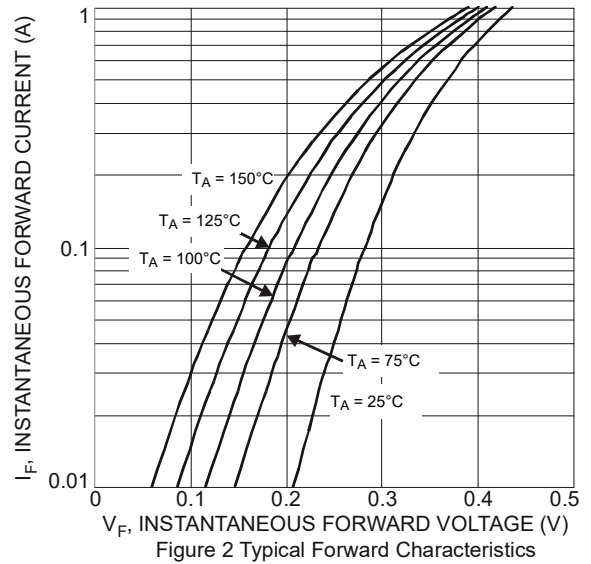
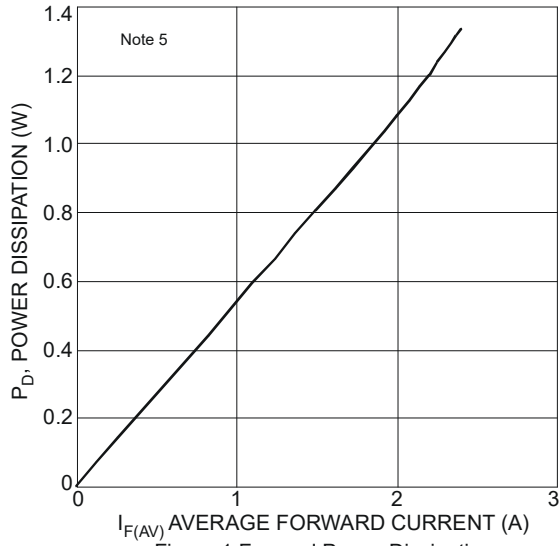
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Case (Note 5)	R _{θJC}	40	°C/W
Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	110	
Thermal Resistance Junction to Case (Note 6)	R _{θJC}	8	
Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	75	
Thermal Resistance Junction to Solder Point (Note 6)	R _{θJS}	25	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	40	—	—	V	I _R = 200μA
Forward Voltage Drop	V _F	—	0.44	0.51	V	I _F = 1A, T _J = +25°C
Leakage Current (Note 7)	I _R	—	20	100	μA	V _R = 40V, T _J = +25°C

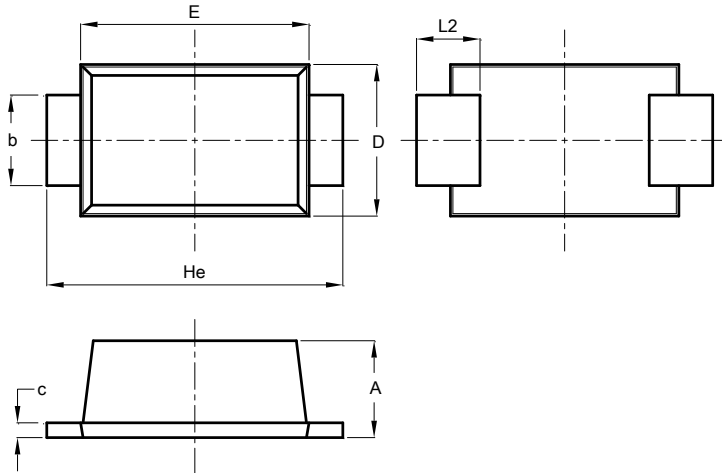
Notes:
 5. Device mounted on 1*MRP FR-4 PC board, 2oz.
 6. Device mounted on 1-inch sq. copper pad, 2oz.
 7. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F

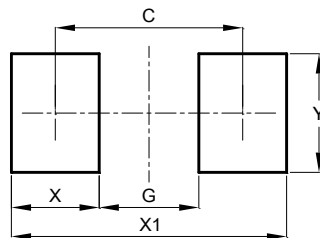


SOD123F			
Dim	Min	Max	Typ
A	0.81	1.15	-
b	0.80	1.05	-
c	0.05	0.30	-
D	1.70	1.90	1.80
E	2.60	2.80	2.70
He	3.30	3.70	3.50
L2	0.35	0.85	-
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123F



Dimensions	Value (in mm)
C	2.86
G	1.52
X	1.34
X1	4.20
Y	1.80

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